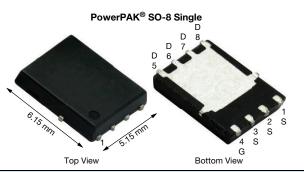
SiRA64DP

www.vishay.com



PRODUCT SUMMARY	
V _{DS} (V)	30
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00210
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00286
Q _g typ. (nC)	19.7
I _D (A) ^{a, g}	60 ^{a, g}
Configuration	Single

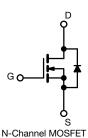
FEATURES

N-Channel 30 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- Optimized Q_g, Q_{gd}, and Q_{gd}/Q_{gs} ratio reduces switching related power loss
- 100 % R_a and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- VRMs and embedded DC/DC
- Synchronous buck converter
- Load switching



ORDERING INFORMATION

Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiRA64DP-T1-RE3

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unless	s otherwise note	ed)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	30	v
Gate-source voltage		V _{GS}	+20, -16	- V
	T _C = 25 °C		60 g	
Continuous durin comment (T. 150.80)	T _C = 70 °C	1 . [60 g	
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	37 ^{b, c}	
	T _A = 70 °C		30 b, c	
Pulsed drain current (t = 100 µs)		I _{DM}	100	- A
Ocationary durin diada compat	T _C = 25 °C		23 ^g	
Continuous source-drain diode current	T _A = 25 °C	I _S	4.2 ^{b, c}	
Single pulse avalanche current		I _{AS}	30	
Single pulse avalanche current L = 0.1 m Single pulse avalanche energy L = 0.1 m		E _{AS}	45	mJ
	T _C = 25 °C		27.8	
	T _C = 70 °C		17.8	10/
Maximum power dissipation	T _A = 25 °C	P _D	5 b, c	- W
	T _A = 70 °C	1	3.2 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	*0
Soldering recommendations (peak temperature) d, e	Ŭ,	260	- °C

THERMAL RESISTANCE RATING	S				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{b, f}	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	3.4	4.5	0/10

Notes

a. Based on T_C = 25 °C

b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

See solder profile (<u>www.vishav.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

Maximum under steady state conditions is 70 °C/W f.

Package limited g.

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For technical questions, contact: pmostechsupport@vishay.com



COMPLIANT HALOGEN FREE



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SiRA64DP

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			<u> </u>			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	18	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6.2	-	mV/°
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.1	-	2.2	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +20 V, -16 V$	-	-	± 100	nA
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	V= 30 V, $V_{DS GS}$ = 0 V, T_{J} = 55 °C	-	-	10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	40	-	-	Α
	_	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.00180	0.00210	0
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.00220	0.00286	Ω
Forward transconductance ^a	g _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	70	-	S
Dynamic ^b	1 1				1	
Input capacitance	C _{iss}		-	3420	-	
Output capacitance			-	1100	-	pF
Reverse transfer capacitance	C _{rss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	81	-	
C _{rss} /C _{iss} ratio			-	0.024	0.048	
	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$					
Total gate charge	Qg		-	19.7	30	
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	8.1	-	nC
Gate-drain charge			-	2.9	-	
Output charge	Q _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$	-	37	-	
Gate resistance	Rg	f = 1 MHz	0.2	0.8	1.6	Ω
Turn-on delay time	t _{d(on)}		-	13	25	
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	15	30	
Turn-off delay time	t _{d(off)}	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω	-	25	50	
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	24	48	ns
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	45	70	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{V}_{\text{GEN}} = 4.5 \text{V}, \text{R}_\text{g} = 1 \Omega$	-	30	60	-
Fall time	t _f		-	15	30	
Drain-Source Body Diode Characteristic	I					
Continuous source-drain diode current	IS	T _C = 25 °C	-	-	23	
Pulse diode forward current (t = 100 µs)	I _{SM}		-	-	100	A
Body diode voltage	V _{SD}	I _S = 10 A	-	0.73	1.2	V
Body diode reverse recovery time	t _{rr}		-	40	80	ns
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	34	70	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	20	-	
Reverse recovery rise time	t _b		-	20	1	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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55 °C

3.0

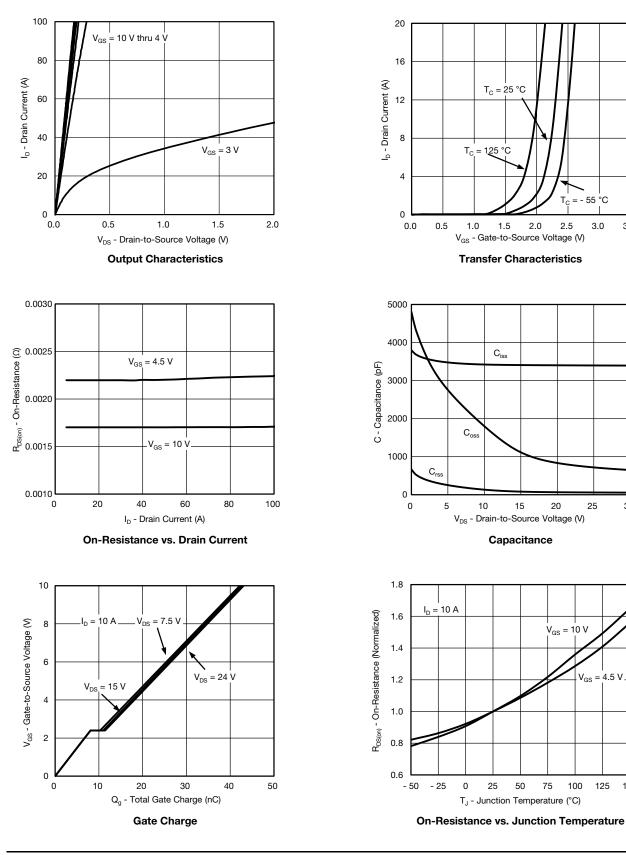
25

 V_{GS} = 4.5 V

30

3.5

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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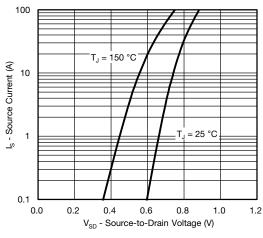
150

125

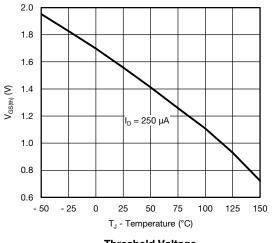
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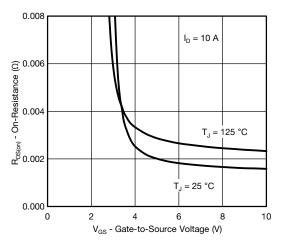
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



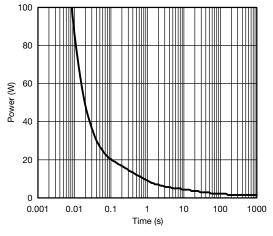
Source-Drain Diode Forward Voltage



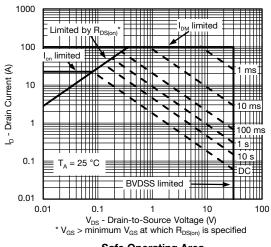
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area

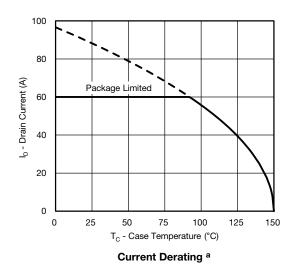
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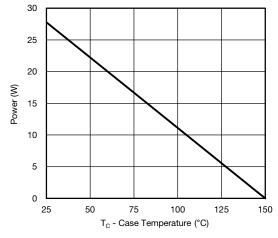


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



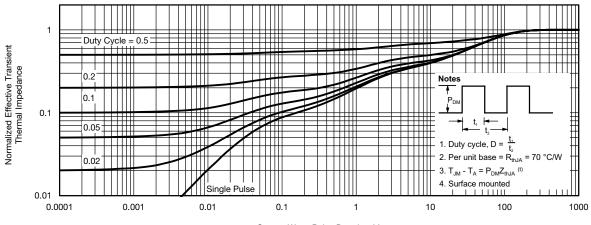
Power, Junction-to-Case



SiRA64DP

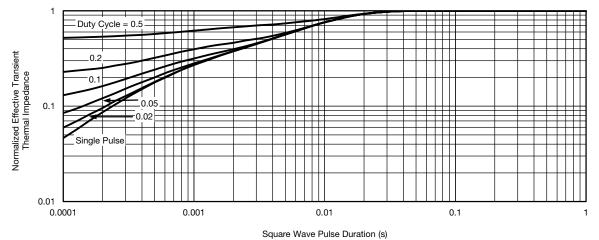
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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D2

E3

Backside View of Dual Pad



Vishay Siliconix

PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
А	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.00		
b	0.33	0.41	0.51	0.013	0.016	0.02		
С	0.23	0.28	0.33	0.009	0.011	0.01		
D	5.05	5.15	5.26	0.199	0.203	0.20		
D1	4.80	4.90	5.00	0.189	0.193	0.19		
D2	3.56	3.76	3.91	0.140	0.148	0.154		
D3	1.32	1.50	1.68	0.052	0.059	0.066		
D4		0.57 typ.		0.0225 typ.				
D5		3.98 typ.			0.157 typ.			
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	5.79	5.89	5.99	0.228	0.232	0.23		
E2	3.48	3.66	3.84	0.137	0.144	0.15		
E3	3.68	3.78	3.91	0.145	0.149	0.154		
E4		0.75 typ.			0.030 typ.			
е		1.27 BSC			0.050 BSC			
К		1.27 typ.		0.050 typ.				
K1	0.56	-	-	0.022	-	-		
Н	0.51	0.61	0.71	0.020	0.024	0.028		
L	0.51	0.61	0.71	0.020	0.024	0.028		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	-	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
М		0.125 typ. 0.005 typ.						

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Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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